

### 3.5x2.8mm SURFACE MOUNT LED LAMP

Part Number: AA3528AMGC

Mega Green

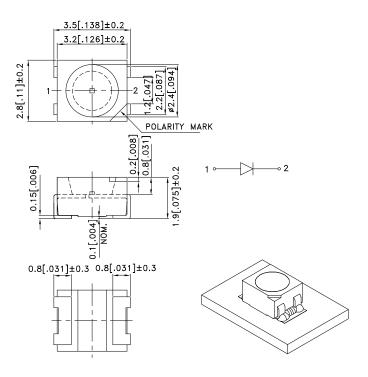
### **Features**

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package: 1500pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

### Description

The Mega Green source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

## **Package Dimensions**



- 1. All dimensions are in millimeters (inches)
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- Specifications are subject to change without notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAH4231 APPROVED: WYNEC

REV NO: V.4 **CHECKED: Allen Liu**  DATE: MAR/30/2009 DRAWN: Ting.Li

PAGE: 1 OF 5 ERP: 1201004045

Downloaded from Elcodis.com electronic components distributor

## **Selection Guide**

Part No.	Dice	lv (mcd) [2] Dice Lens Type @ 20mA			Viewing Angle [1]
			Min.	Тур.	201/2
AA3528AMGC	Mega Green (AlGaInP)	WATER CLEAR	70	150	120°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Mega Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Mega Green	26		nm	IF=20mA
С	Capacitance	Mega Green	20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Mega Green	2.1	2.5	V	I=20mA
lr	Reverse Current	Mega Green		10	uA	V <sub>R</sub> =5V

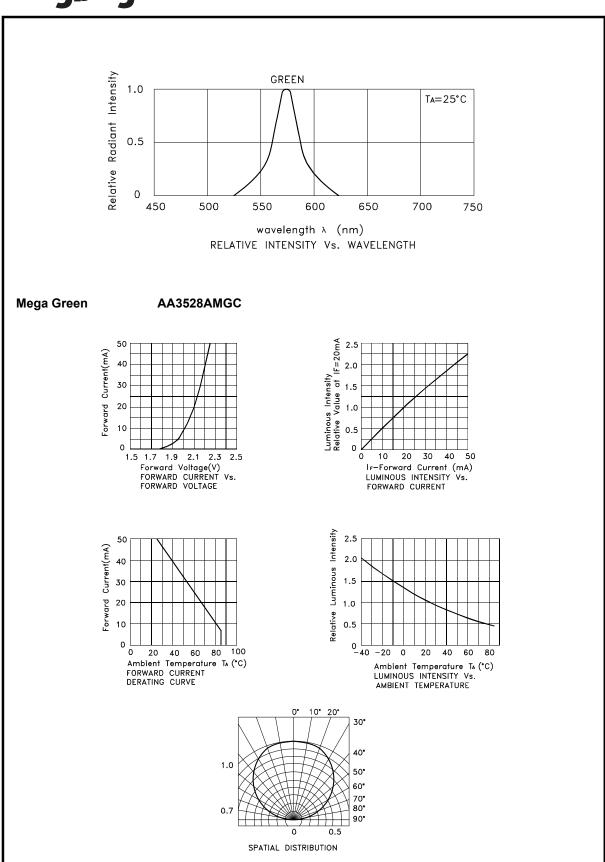
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

Parameter	Mega Green	Units	
Power dissipation	125	mW	
DC Forward Current	50	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

REV NO: V.4 SPEC NO: DSAH4231 DATE: MAR/30/2009 PAGE: 2 OF 5 CHECKED: Allen Liu APPROVED: WYNEC DRAWN: Ting.Li ERP: 1201004045



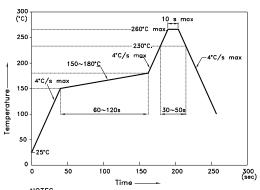
SPEC NO: DSAH4231 REV NO: V.4 DATE: MAR/30/2009 PAGE: 3 OF 5

APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Ting.Li ERP: 1201004045

### AA3528AMGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



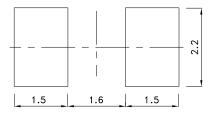
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

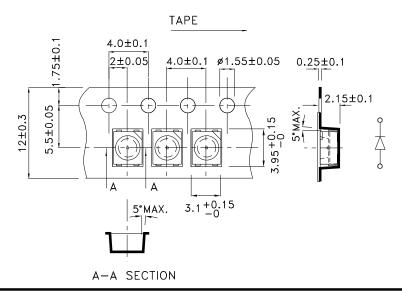
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

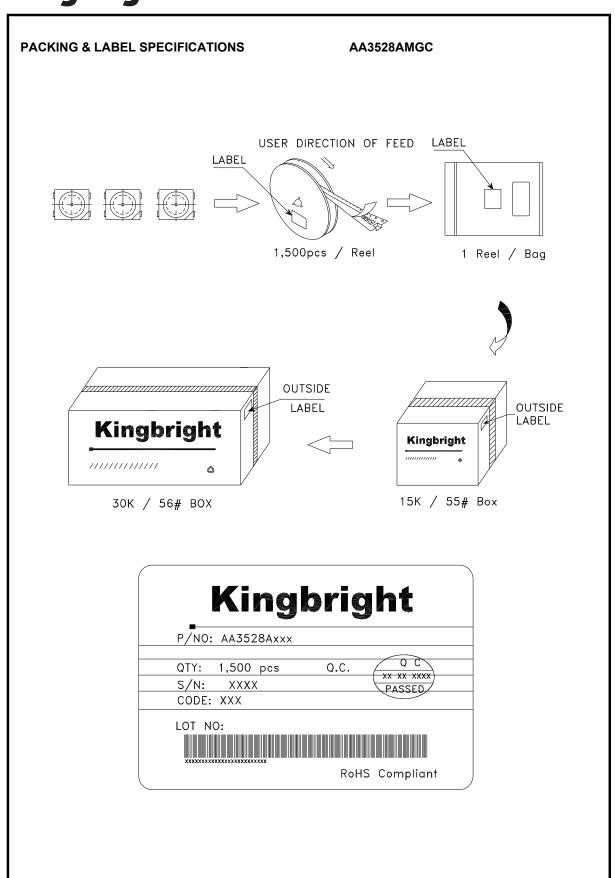
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## Tape Dimensions (Units : mm)



SPEC NO: DSAH4231 APPROVED: WYNEC REV NO: V.4 CHECKED: Allen Liu DATE: MAR/30/2009 DRAWN: Ting.Li PAGE: 4 OF 5 ERP: 1201004045



SPEC NO: DSAH4231 APPROVED: WYNEC REV NO: V.4 CHECKED: Allen Liu DATE: MAR/30/2009 DRAWN: Ting.Li PAGE: 5 OF 5 ERP: 1201004045